



# Status of 3D R&D in Freiburg

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12<sup>th</sup> RD50 Collaboration Meeting, Ljubljana





# Introduction



- Module overview
- Lab test results
- Test beam set-up & analysis
- Conclusions



# The Modules



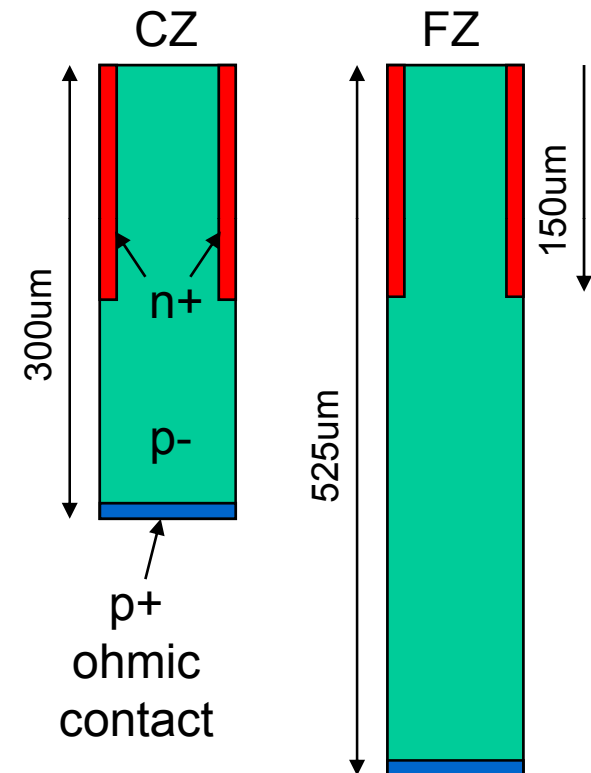
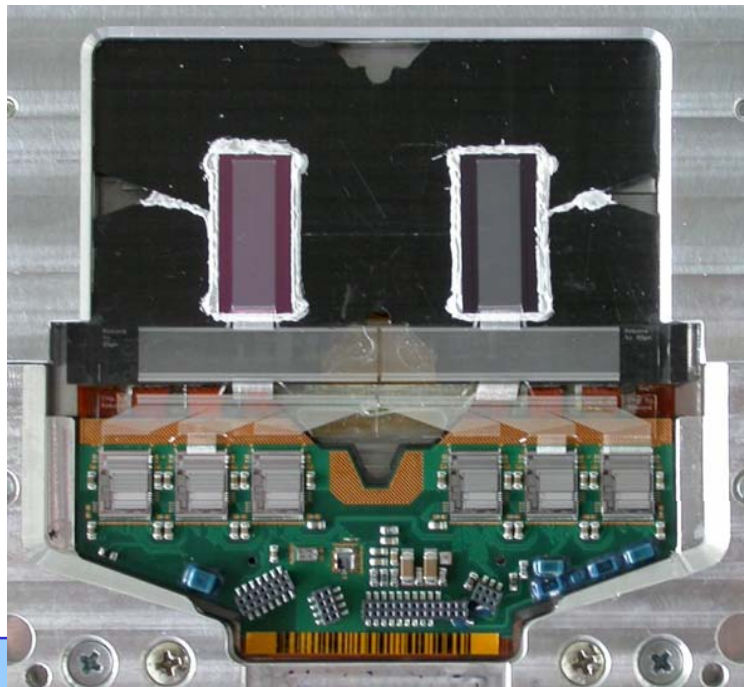
- Available modules
  - Sensors are 3D-microstrip devices made by fbk-IRST
  - Fanins custom-made in house
  - Electronics: most modules use ATLAS SCT readout from EC module production
  - One module uses LHCb-Velo readout with Beetle-ASICs. This was in the test beam.



# 3D-STC Module



- Module with two 3D-STC sensors
- Irradiated to  $0.98 \cdot 10^{15} N_{eq}/cm^2$ 
  - 80 $\mu m$  strip and inter-column pitch, 230 columns per strip, 64 strips,  $\sim 2$ cm strip length matched to short strip layer in SLHC trackers
  - 2 sensors: FZ (CZ) p-type substrate, p-spray isolation, 525  $\mu m$  (300 $\mu m$ ) thick



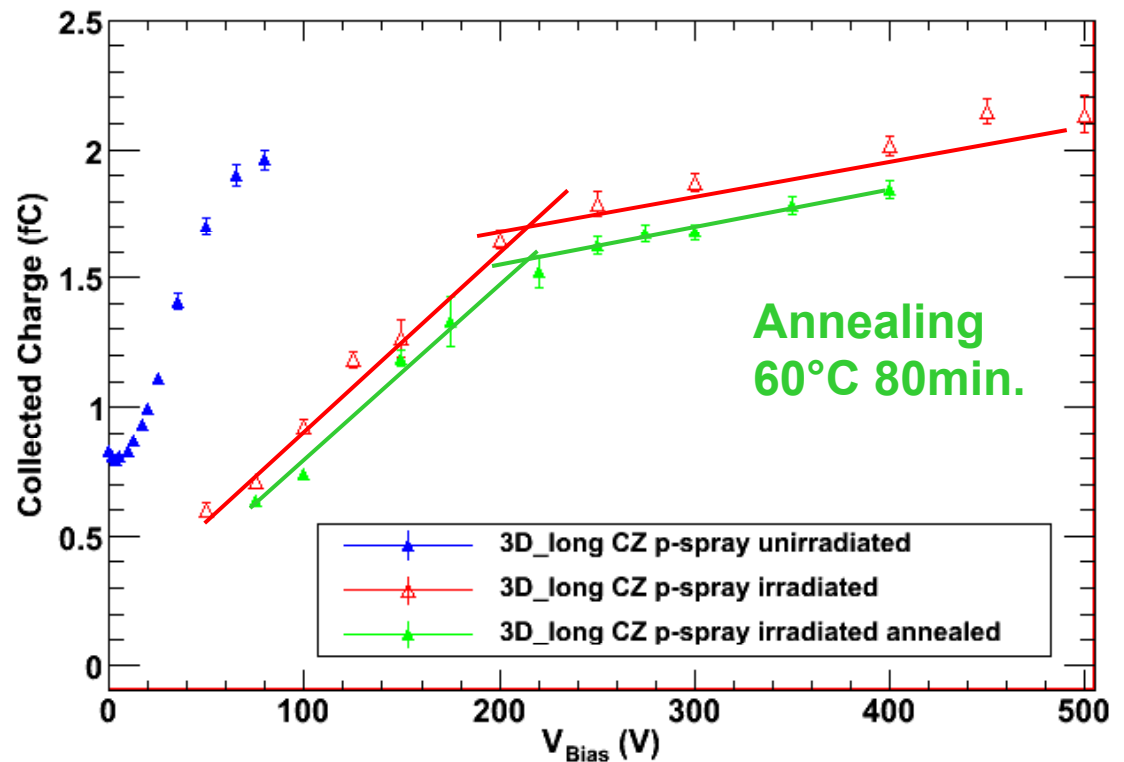


# CZ p-type



- Sr90 beta source measurements on irradiated 3D-STC after annealing
- $V_{FD} \sim 230V$  as predicted for CZ p-type
- Charge collection is reduced by irradiation, and also slightly by annealing
- Post-annealing effect could be explained by
  - Increased hole trapping
  - Hole trapping is important between columns
  - Simulations by Andrea Zoboli

Expected  $V_{LAT} = 33V$   
Expected  $V_{FD} = 230V$

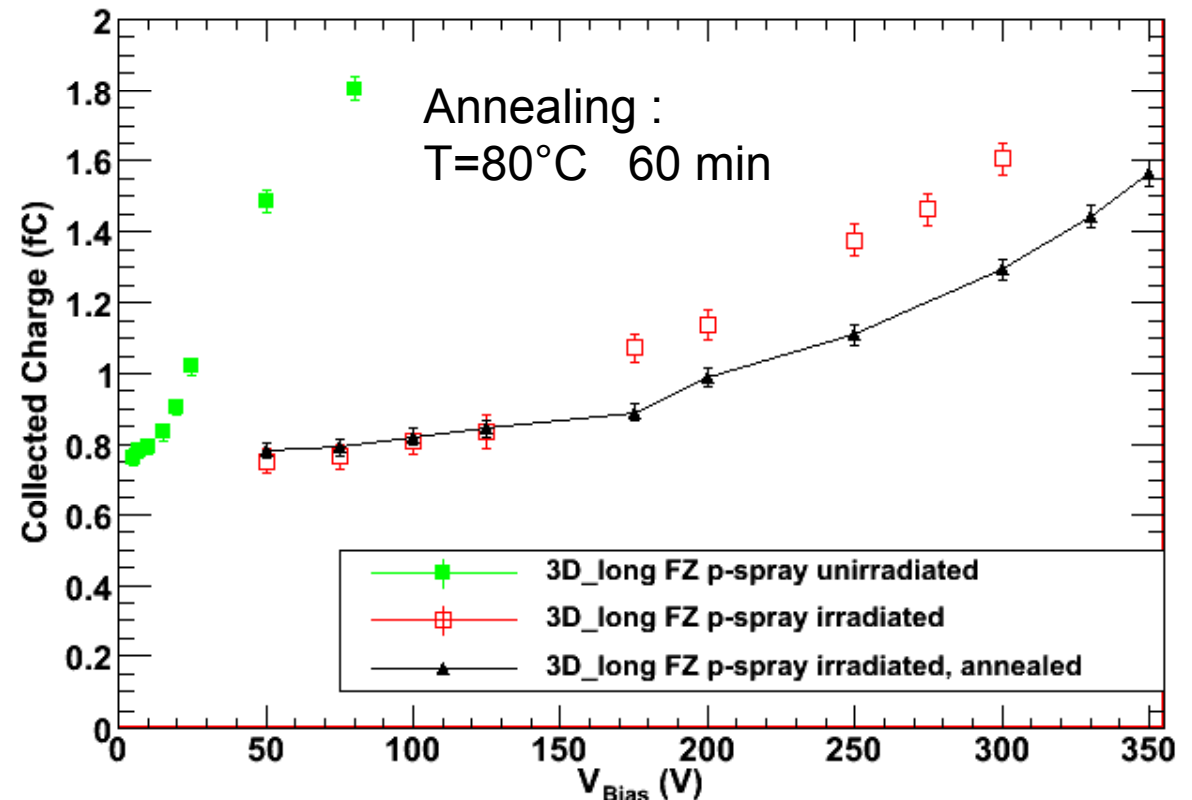




# FZ p-type



- Total depletion unreachable due to onset of micro discharge
- Note high annealing T will move into reverse annealing regime
- Due to reverse annealing  $N_{eff}$  increases  
→ less charge after annealing due to smaller depleted volume underneath the columns.



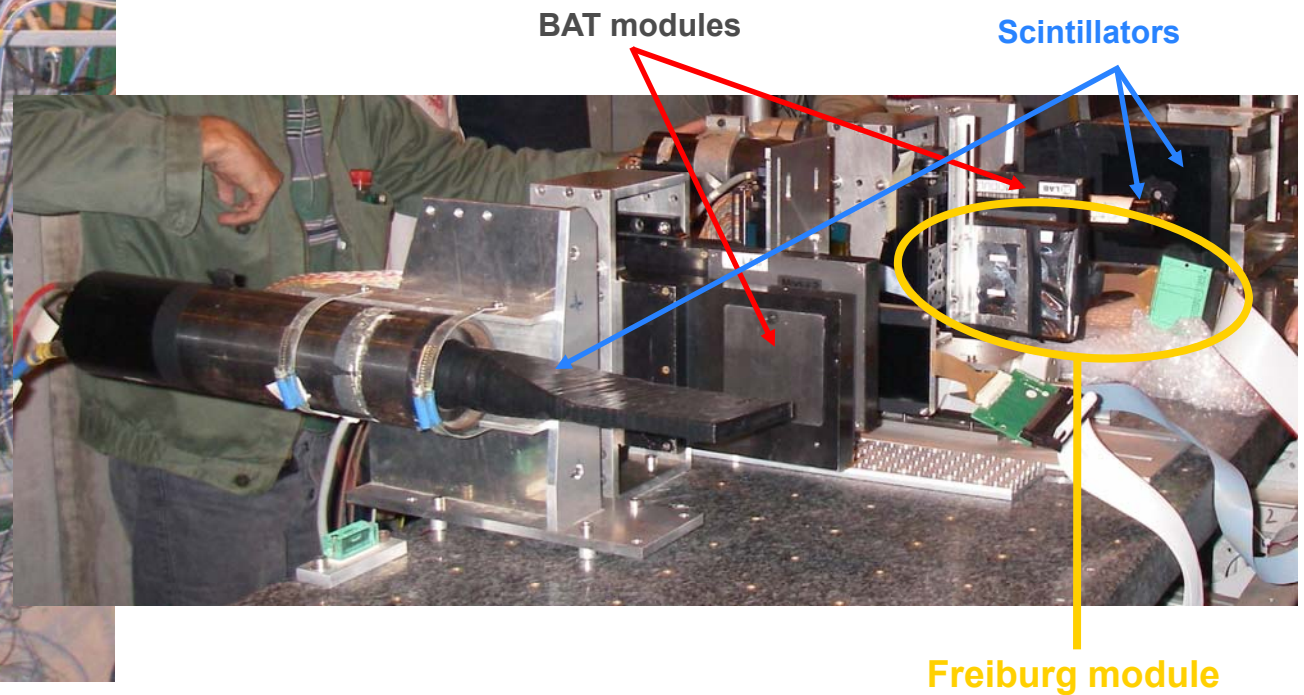
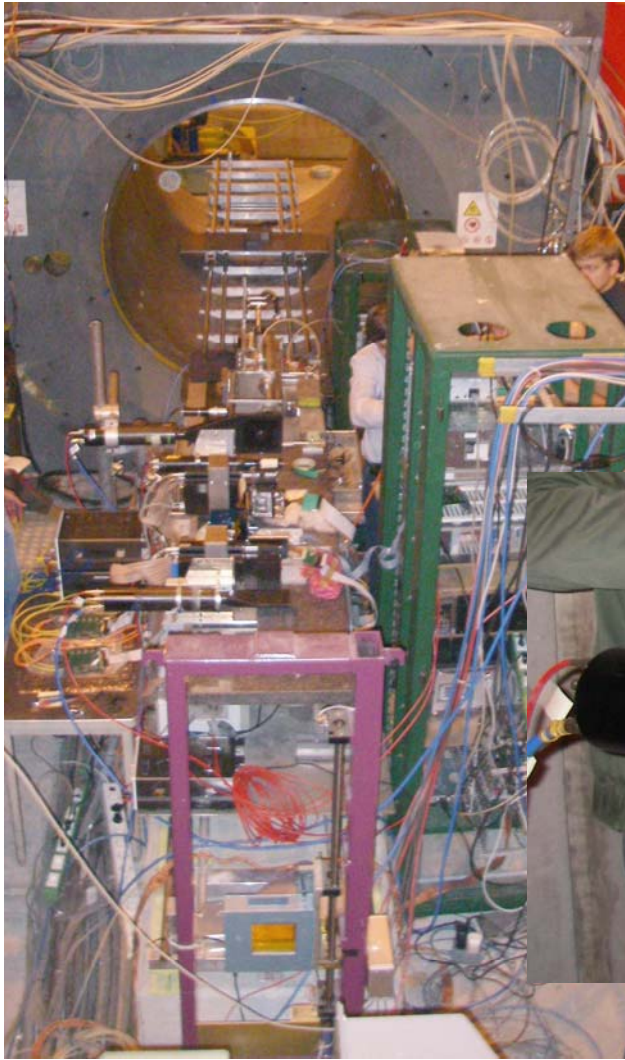




# 3D Test beam



- ATLAS 3DSi test beam 2007 at CERN H8 area
- This work: close collaboration with Glasgow
- 180 GeV  $\pi$  beam
- Bonn ATLAS Telescope (BAT), 5 $\mu$ m resolution





# Testbeam Module

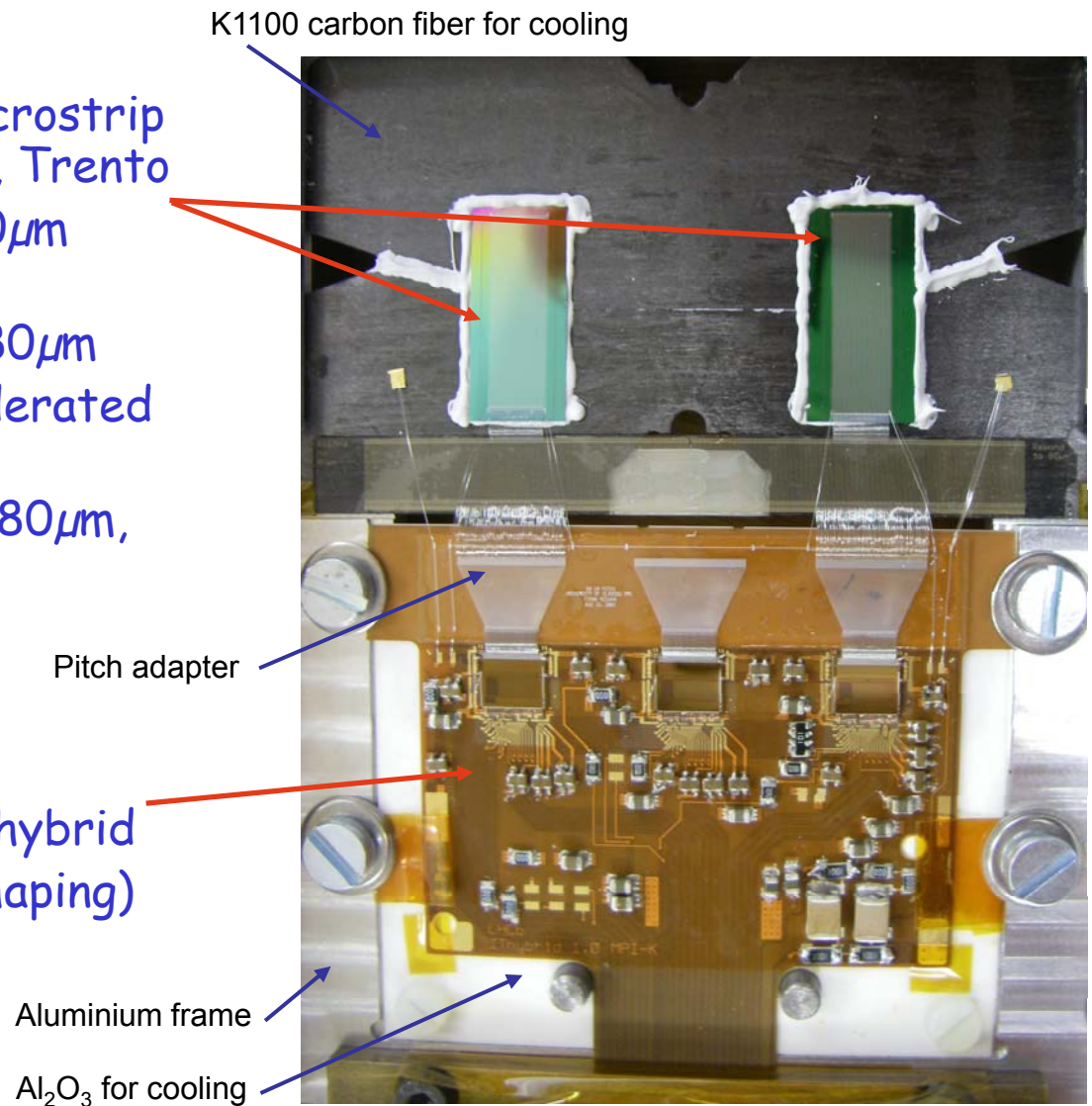


- Sensors

- 3D-STC n<sup>+</sup>-on-p mCz microstrip devices from fbk-IRST, Trento
- Thickness: 300 $\mu$ m / 380 $\mu$ m
- Strips: 64 per sensor, length 18.4mm, pitch 80 $\mu$ m
- Isolation: p-spray / moderated p-spray
- Columns: pitch 100 $\mu$ m / 80 $\mu$ m, depth 150 $\mu$ m

- Readout

- Analogue 40MHz LHCb hybrid
- Beetle ASICs (~25ns shaping)
- 5 consecutive time bins





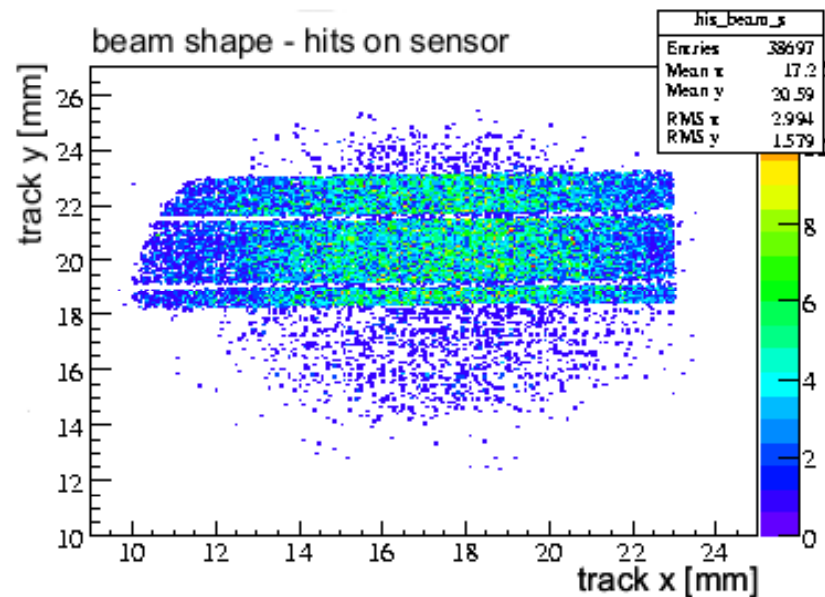
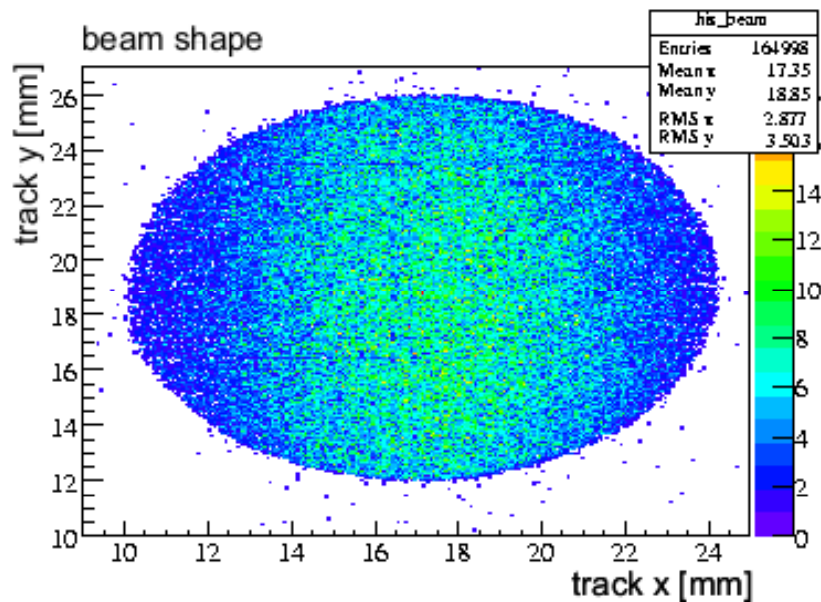


# Test Beam Data



## Track information (Ole Rohne)

- Starting point:  $x$ ,  $y$  track coordinates
- Beam shape: track  $y$  vs. track  $x$  (left plot)
- Track  $x, y$  for events where the 3D sensor registered a hit

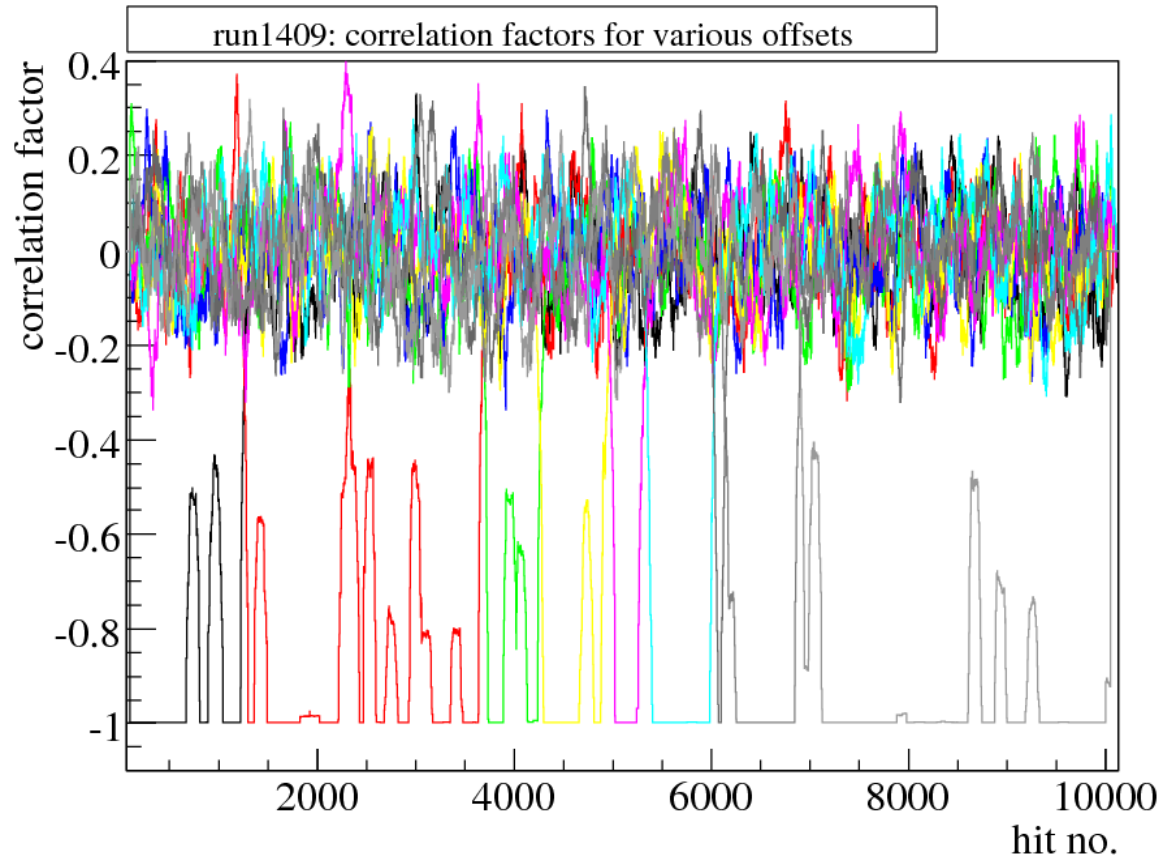




# Desynchronisation



- So far the data look promising
- But data analysis proved very problematic
- Caused by two parallel DAQ systems that frequently lose synchronisation
- Event offset between DAQs must be found from data (using correlation between telescope and 3D sensor)
- Typical length of clean run sequence ~500 events
- In addition to that, main DAQ has internal trigger losses

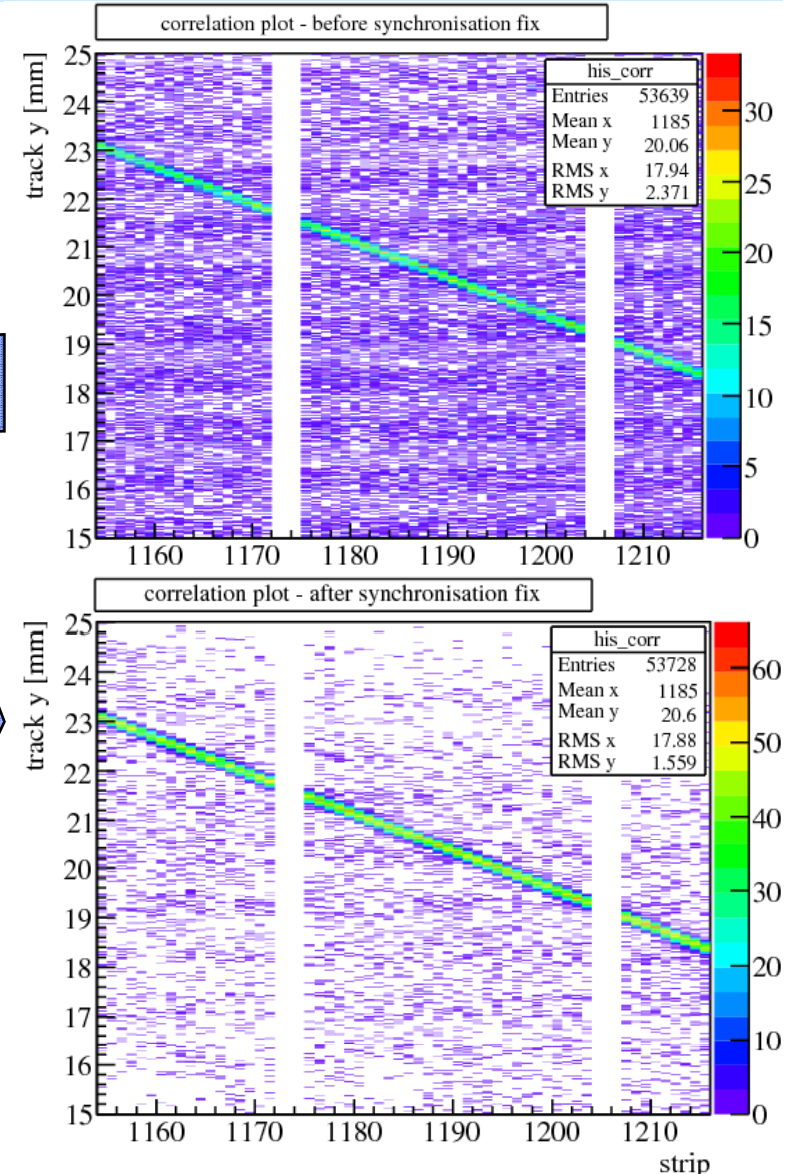




# Re-Synchronisation



- Re-Synchronisation fix improves data sample massively
- Fix cannot recover all events  $\rightarrow$  uncorrelated hits make alignment difficult and need to be excluded
- Fit correlation line by slicing 2D histogram and retrieving the  $y$  maximum for each strip from Gauss fit
- Use only hits within  $3\sigma \approx 200\mu\text{m}$  for alignment ( $\approx 91\%$ )

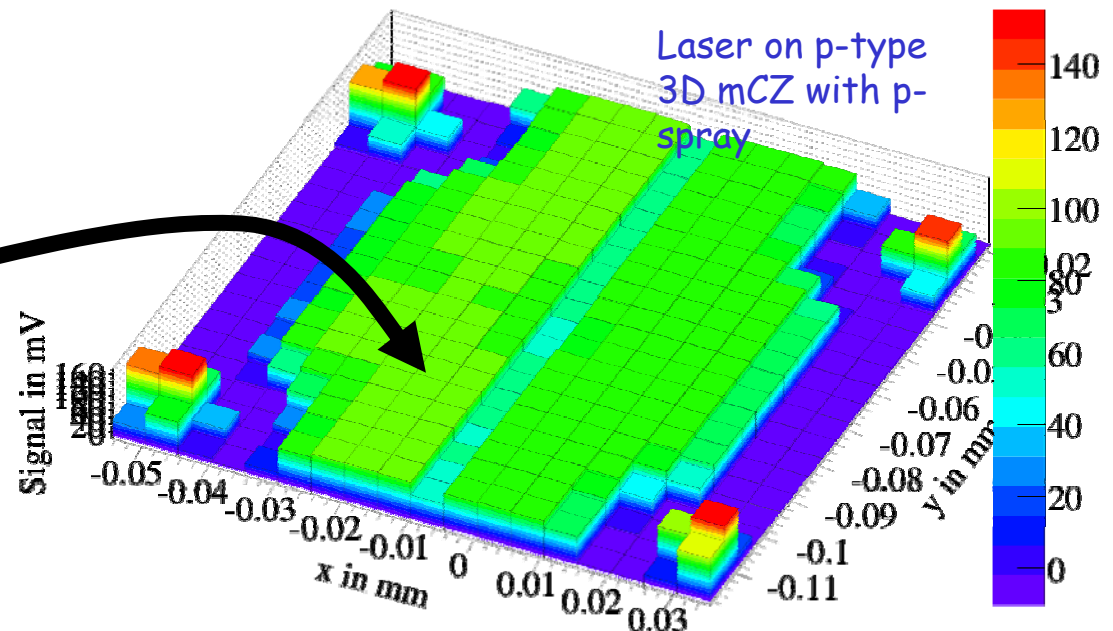
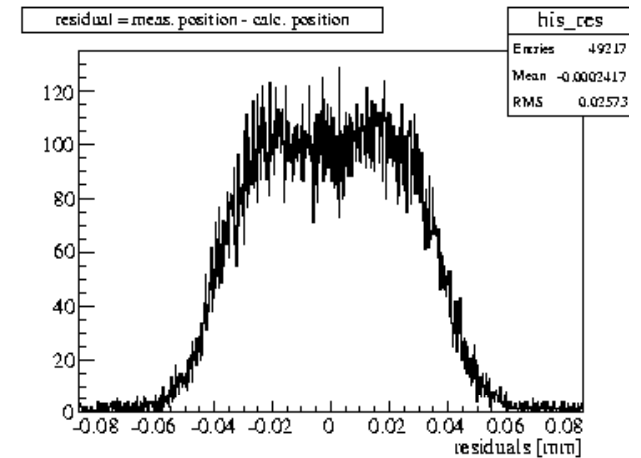
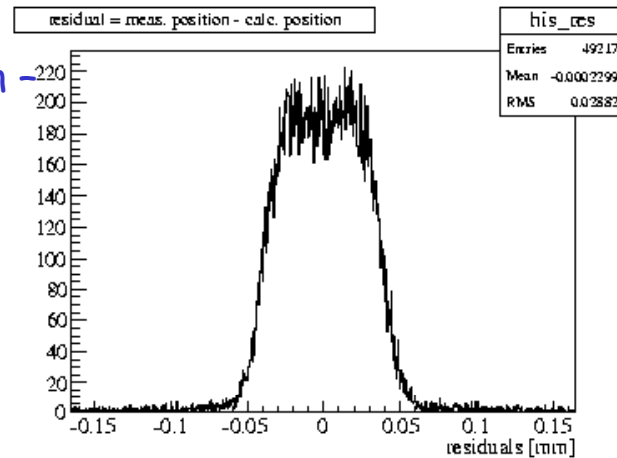




# Alignment



- Calculate residual (extrapolated track position - measured hit position)
- Minimize it
- Alignment converges
- Residual:  $\sim 26\mu\text{m}$  (c.f. binary:  $23\mu\text{m}$  from  $80\mu\text{m}/\sqrt{12}$ )
- So far only small sub-set of data analysed. Requires effort from central DAQ (Ole Rohne)
- Strategy: fold all data onto one unit cell to look for local variation of CCE as expected from simulation & Laser tests
- Results expected in autumn after Gregor Pahn finishes his thesis

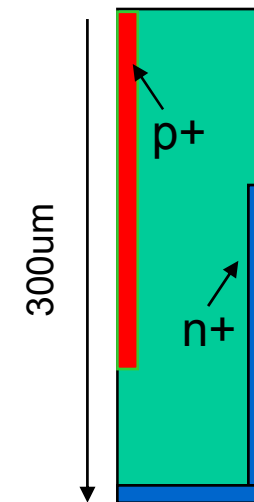
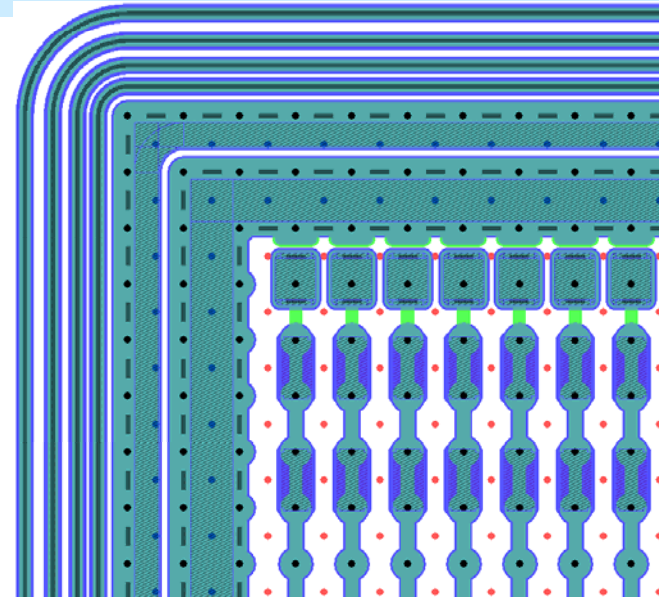




# Ongoing work: Double Type Column



- The new geometry is an important step as for CCE and radiation hardness
- In Freiburg: 4 DDTC p-in-n strip sensors from first batch (again from fbk-IRST)
- 300 $\mu\text{m}$  thick, 190  $\mu\text{m}$  column depth
  - Column overlap only 80 $\mu\text{m}$
- Size 1cm x 1cm, 80 $\mu\text{m}$  inter/intra column pitch
- 102 strips and 102 col/strip
- Devices show early breakdown, but can be fully depleted
- 2 DDTC modules were made with ATLAS SCT readout, source and laser testing still ongoing



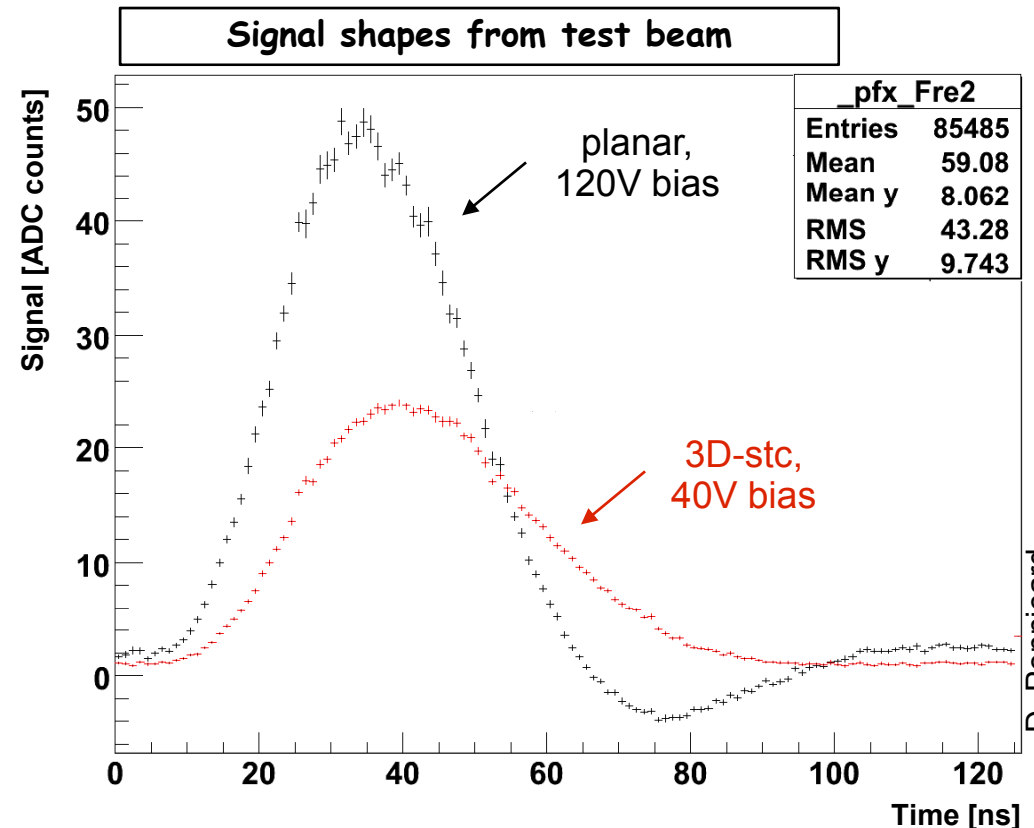




# Comments on 3D-STCs



- Overall charge level low (2.2fC) due to ballistic deficit arising from 3D-STC field configuration
- This will be improved with new Double Type Column Designs
- 3D-STC after irradiation to  $10^{15}N_{eq}/cm^2$  are still operational
- Same CCE as unirradiated device, but at much higher bias voltage
- The annealing has affected the CCE:
  - On CZ probably due to trapping of holes between columns
  - On FZ mostly because the annealing was too long and  $N_{eff}$  has increased significantly
- Modules recently taken to another irradiation step, total dose now  $\sim 3.5 \cdot 10^{15}N_{eq}/cm^2$
- Testing in Sr90-system is running this week



Need to move from STC to DTC!



# Conclusions & Outlook



- Work on STC 3D devices (originally intended as technology test) is coming to an end.
  - STCs are radiation hard
  - Too slow for a 40 MHz SLHC (field configuration)
  - Still have some STC measurements in the pipeline
    - Two modules irradiated to  $3.5 \cdot 10^{15} N_{eq}/cm^2$  in source and laser test systems
    - Completion of 2007 test beam analysis
- Future 3D tests will concentrate on DDTC devices
- Last testbeam analysis has many complications, given by separate DAQs
- We plan to participate in CMS testbeam this summer, in the spirit of RD50



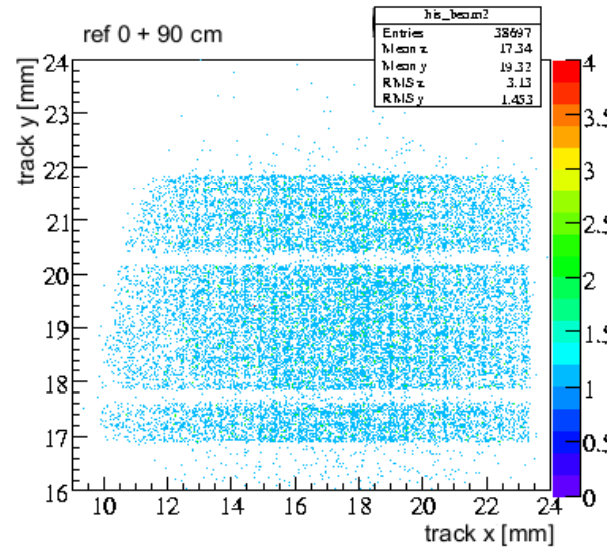
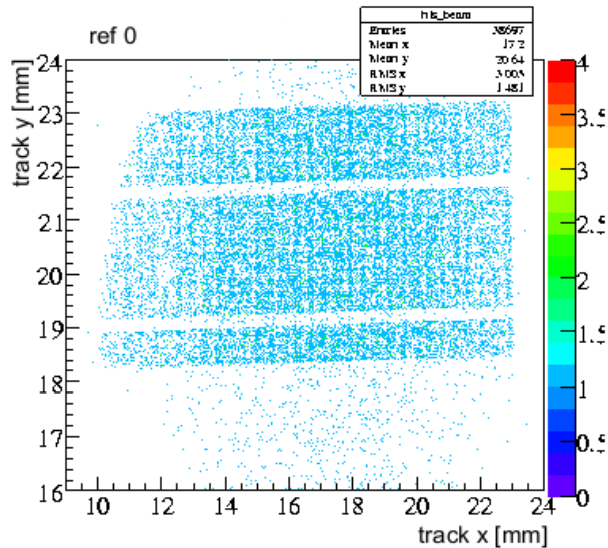
# Backup





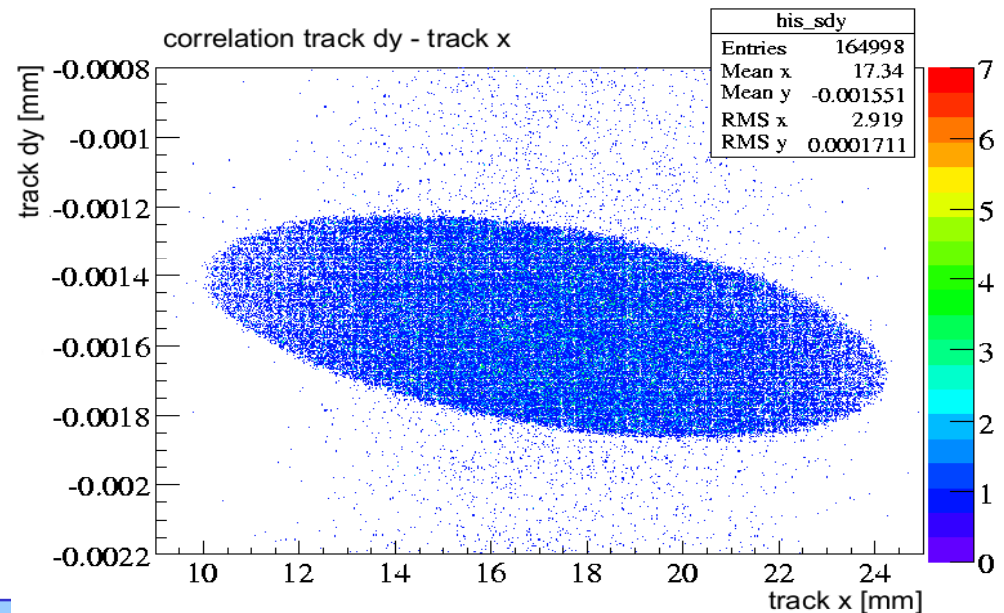


# Finding start values



- ▶ Upper left: projection of sensor into track reference system ref 0
- ▶ Sensors positioned ca. 90cm downstream ref 0
- ▶ Upper right: tracks extrapolated 90cm downstream in a plane parallel to ref 0

- choose sensor system origin in lower right corner → start values for 3 offset parameters
- Sensor should only be shifted in x and y
- Why is there also a rotation?
  - x and dy correlated







# Exclude uncorrelated hits



- Synchronisation fix cannot recover all events → uncorrelated hits make minimization unreliable and need to be excluded
- Fit correlation line in ref 0 by slicing the 2D histogram and retrieving the  $y$  maximum for each strip from Gauss fit
- Use only hits within  $3\sigma \approx 200\mu\text{m}$  for alignment ( $\approx 91\%$ )

